



RJ45, MODULAR JACK, 8 POSITION, 8 CONTACTS, SHIELD, WITH LEDS

1.0 SCOPE

THIS PRODUCT SPECIFICATION COVERS THE 1.27mm (.050 inch) CENTERLINE (pitch) PRINTED CIRCUIT BOARD (PCB) MODULAR JACK CONNECTOR SERIES WITH SELECTIVE GOLD AND TIN PLATING.

2.0 PRODUCT DESCRIPTION

2.1 PRODUCT NAME AND SERIES NUMBER(S)

RJ45, MODULAR JACK 8 POSITION, 8 CONTACTS, SHIELD, WITH LEDS P/N : GDR11-A3-08001 GDR19-A3-080*100

2.2 DIMENSIONS, MATERIALS, PLATINGS AND MARKINGS

SEE THE CPPROPRIATE SALES DRAWINGS FOR INFORMATION ON DIMENSIONS, MATERIALS, PLATING AND MARKINGS.

3.0 APPLICABLE DOCUMENTS AND SPECIFICATIONS

FCC RULES AND REGULATIONS, PART 68, SUBPART F ANSI/EIA/TIA-568 IEC-60603-7 UL 1863 MIL-STD-202 EIA-364

4.0 RATINGS OF CONNECTOR

- 1. Rate Voltage: 150 V _{RMS} AC Rate Current: 1.5 A
- 2. Operating temperature: -40°C to +70°C

REVISION:	ECR/ECM	N INFORMAT	PRODUCT NO		GDR11 & GDR19 se	SHEET No		
	EC No:			PRODUCT		RJ45,MODULAR JACK		
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5.0 PERFORMANCE

5.1 ELECTRICAL REQUIREMENTS

DESCRIPTION	TEST CONDITION	REQUIREMENT
Contact Resistance	Mate connectors: apply a maximum voltage of 20 mV and a current of 100 mA.	20 milliohms (initial) 40 milliohms (final)
Insulation Resistance	Unmated connector, mounted to a PCB: apply a voltage of 100 VDC between adjacent terminals and between terminals to ground.	500 Megohms MINIMUM
Dielectric Withstanding Voltage	1000 VAC (1mA cutoff current) for 60 seconds duration between adjacent terminals and terminals.	No Breakdown
Current Temperature Rating	Mate connector and measure the temperature rise at the rated current (1.5Amps).	$30^\circ C$ rise maximum from initial

5.2 MECHANICAL REQUIREMENTS

		DESCRIPTION			ST CONDIT	ION		REQUIREMENT			
		Connecto Force	or Mate		e connector ⊧ 6 mm (1 ± ĵ		35 N (8 lbf) MAXIMUM				
		Durability	1	max		f 10 cy	750 cycles at a cles per minute Tests.		illiohms (initial illiohms (final)		
		Vibration (Random)			olitude: 1.50r eep: 10-55-10 ation: 15 min ection: X, Y,2	0 Hz in iutes	20 milliohms (initial) 40 milliohms (final)				
		Plug Rete	ention Force	Force Apply an axial pullout force on the plu a rate of 25 ± 6 mm ($1 \pm \frac{1}{4}$ inch).					89 N (20 lbf) MINIMUM		
		Shock (Mechani	ical)	Mate connectors and shock at 50 G Half-sine,11ms form shocks in the X, Y, Z axis (9 shocks total).					20 milliohms (initial) 40 milliohms (final)		
		Solderab	ility	(hel	Dip solder tails into the molten solder (held at $245 \pm 5^{\circ}$ C) up to 1.0mm from the bottom of the housing fo 5 ± 1 second			Solderable area shall have minimum of 95% solder coverage			
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5.3 ENVIRONMENTAL REQUIREMENTS

DE	SCRIPTIO	N		TEST CON	IDITIO	N	REQ			
Shc (Th	ock ermal)	Mate -40°C 30 mil	to +8		e to 10	20 milliohms (initial) 40 milliohms (final) & Visual: No Damage				
The	rmal Aging			ectors; expose at 85±2°C	e to:		20 milliohms (initial) 40 milliohms (final) & Visual: No Damage			
	nidity cling)	10 cyc tempe MIL-S	cles a eratur TD-2	ectors: expose It 90-95% rela es at +25°C a 02F method 1 0°C dip)	tive hu nd +6	20 milliohms (initial) 40 milliohms (final) & Dielectric Withstanding Voltage: No Breakdown at 500 VAC & Insulation Resistance: 200 Megohms MINIMUM & Visual: No Damage				
Sol Res	der sistance	Solde Solde {Reco	Dip connector terminal tails in solder: Solder Duration: 5±0.5 seconds Solder Temperature: 260±5°C (Recommended same parameters as SMES-152.}					Visual: No Damage to insulator material		
Salt	Spray		5±1% salt solution Duration 48 hrs					20 milliohms (initial) 40 milliohms (final) & Visual: No Damage		
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ACRON PRODUCT SPECIFICATION

5.4 Test Group

		Test Group								
Test Item	Α	В	С	D	Individua					
Examination of Product	1,5	1,8	1,5	1,6						
Contact Resistance	4		2,4	2,5						
nsulation Resistance	-	2,6								
Dielectric Withstanding Voltage	-	3,7								
Current Temperature Rating	-									
Connector Mate Force	2									
Durability	3									
Vibration (Random)				3						
Shock (Mechanical)				4						
Solderability										
Shock (Thermal)		4								
Thermal Aging			3							
Humidity (Cycling)		5								
Solder Resistance					*					
Salt Spray					*					
Plug Retention Force					*					
Sample Size	5	5	5	5	5					

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6.0 PACKAGING

PARTS SHALL BE PACKAGED TO PROTECT AGAINST DAMAGE DURING HANDING, TRANSIT AND STORAGE. SEE APPRPPRATE SALES DRAWINGS.

7.0 OTHER INFORMATION

7.1 LED ELECTRICAL PERFORMANCE

PARAMETER	GREEN		YELLOW		ORANGE		UNITS	TEST CONDITION
Power Dissipation		60		60	60		nm.	N/A
Reverse Voltage		5.0		5.0	5.0		V	N/A
Peak Wavelength	560~580		580~600		595~615		nm.	IF=20mA
Forward Voltage	2.2	MAX=2.5	2.2	MAX=2.5	2.2	MAX=2.5	V	IF=20mA

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